

ABSTRACT

In a light irradiation device in which a light emitting element is attached to a printed circuit board, the heat radiation properties are enhanced, and improvement of the 5 light emitting efficiency, reduction of the size and weight, and prevention of temporal changes are realized.

[Means for Resolution] A Cu pattern covered with Ni is formed on a metal substrate 11. Light emitting elements 11 10 are mounted on the pattern in the form of a series circuit.

Metal substrates in each of which the series connection is formed are connected to one another in parallel. Since Ni has excellent corrosion resistance and a high reflection efficiency, the surfaces of the substrates themselves can 15 be used as reflective plates. A lens 37 is formed for each of the light emitting elements, whereby the emission efficiency can be further improved.

A transparent substrate 50 is bonded via a seal 51, and temporal changes of a light emitting element 10 and 20 electrodes which are sealed therein are suppressed.